

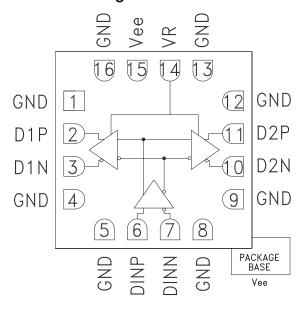


Typical Applications

The HMC720LP3E is ideal for:

- 16 G Fiber Channel
- RF ATE Applications
- Broadband Test & Measurement
- Serial Data Transmission up to 14 Gbps
- Clock Buffering up to 14 GHz

Functional Diagram



Features

Inputs Terminated Internally in 50 Ohms

Differential Inputs are DC Coupled

Propagation Delay: 120 ps

Fast Rise and Fall Times: 19 / 18 ps Programmable Differential Output Voltage Swing: 600 - 1100 mVp-p

Power Dissipation: 300 mW

Single Supply: -3.3 V

16 Lead 3x3 mm SMT Package: 9 mm²

General Description

The HMC720LP3E is a 1:2 Fanout Buffer designed to support data transmission rates up to 14 Gbps, and clock frequencies as high as 14 GHz.

All differential inputs to the HMC720LP3E are CML and terminated on-chip with 50 Ohms to the positive supply, GND, and may be DC or AC coupled. Outputs can be connected directly to a 50 Ohm ground-terminated system or drive devices with CML logic input. The HMC720LP3E also features an ouput level control pin, VR, which allows for loss compensation or signal level optimization. The HMC720LP3E operates from a single -3.3 V supply and is available in ROHS-compliant 3x3 mm SMT package.

Electrical Specifications, $T_A = +25$ °C, Vee = -3.3 V, VR = 0 V

Parameter	Conditions	Min.	Тур.	Max	Units
Power Supply Voltage		-3.6	-3.3	-3.0	V
Power Supply Current			90		mA
Maximum Data Rate			14		Gbps
Maximum Clock Rate			14		GHz
Input Voltage Range		-1.5		0.5	٧
Input Differential Range		0.1		2.0	Vp-p
Input Return Loss	Frequency <13 GHz		10		dB
Output Amplitude	Single-Ended, peak-to-peak		550		mVp-p
	Differential, peak-to-peak		1100		mVp-p
Output High Voltage			-10		mV
Output Low Voltage			-560		mV
Output Rise / Fall Time	Single-Ended, 20% - 80%		19 / 18		ps



RoHS√
E

14 Gbps, FAST RISE TIME 1:2 FANOUT BUFFER w/ PROGRAMMABLE OUTPUT VOLTAGE

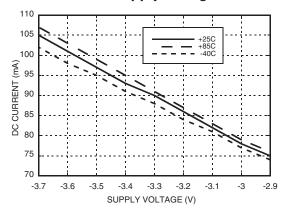
Electrical Specifications (continued)

Parameter	Conditions	Min.	Тур.	Max	Units
Output Return Loss	Frequency <13 GHz		10		dB
Small Signal Gain			27		dB
Random Jitter J _R	rms			0.2	ps rms
Deterministic Jitter, J _D	δ - δ , 2 ¹⁵ -1 PRBS input ^[1]		2	6	ps
Propagation Delay, td			120		ps
D1 to D2 Data Skew, t _{SKEW}			0		ps
VR Pin Current	VR = 0.0 V		2		mA
VR Pin Current	VR = +0.4 V			3.5	mA

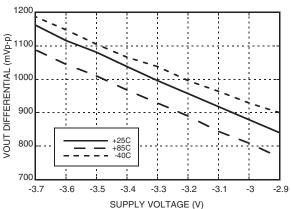
^[1] Deterministic jitter measured at 13 GHz with a 300 mVp-p, 2¹⁵-1 PRBS input sequence.

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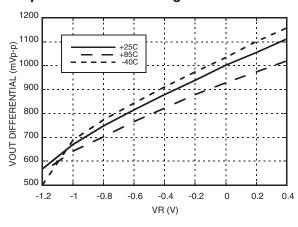
DC Current vs. Supply Voltage [1][2]



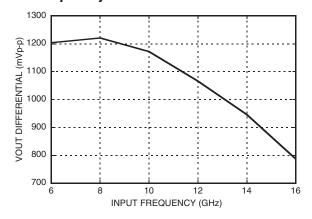
Output Differential Voltage vs. Supply Voltage [1][3]



Output Differential Voltage vs. VR [3][4]



Output Differential Voltage vs. Frequency [1][4]



[1] VR = 0.0 V

[2] Frequency = 13 GHz

[3] Frequency = 10 GHz

[4] Vee = -3.3 V

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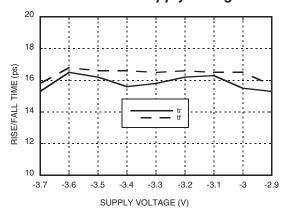
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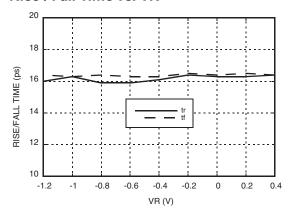


Rise / Fall Time vs. Supply Voltage [1][2]

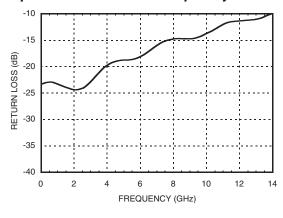
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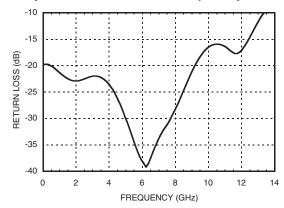
Rise / Fall Time vs. VR [2][3]



Input Return Loss vs. Frequency



Output Return Loss vs. Frequency



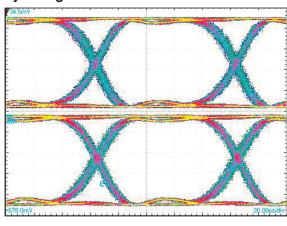


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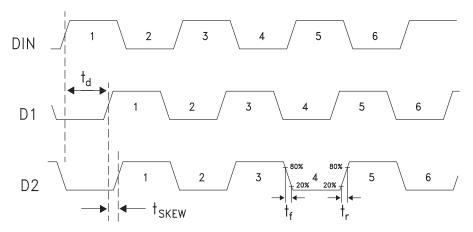
Eye Diagram



[1] Test Conditions:

Pattern generated with an Agilent N4903A Serial BERT. Eye Diagram presented on a Tektronix CSA 8000. Device input = 10 Gbps PN code, Vin = 300 mVp-p differential. Both output channels shown.

Timing Diagram



Truth Table

Input	Outputs		
DIN	D1	D2	
L	L	L	
Н	Н	Н	
Notes: DIN = DINP - DINN D1 = D1P - D1N D2 = D2P - D2N	H - Positive differential voltage L - Negative differential voltage		





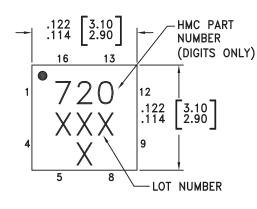
Absolute Maximum Ratings

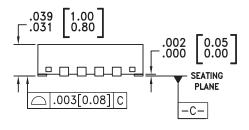
Power Supply Voltage (Vee)	-3.75 V to +0.5 V	
Input Signals	-2 V to +0.5 V	
Output Signals	-1.5 V to +1 V	
Junction Temperature	125 °C	
Continuous Pdiss (T = 85 °C) (derate 20.4 mW/°C above 85 °C)	0.816 W	
Thermal Resistance (Rth _{j-p}) Worst case junction to package paddle	49 °C/W	
Storage Temperature	-65 °C to +150 °C	
Operating Temperature	-40 °C to +85 °C	
ESD Sensitivity (HBM)	Class 1C	

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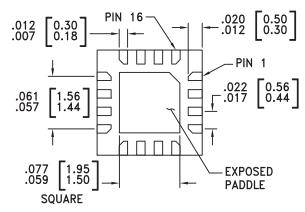


Outline Drawing





BOTTOM VIEW



NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 4. PAD BURR LENGTH SHALL BE 0.15 mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05 mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm.
- 6. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.
- 8. PADDLE MUST BE SOLDERED TO Vee.

Package Information

Part	t Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
НМС	C720LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	<u>720</u> XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX





Pin Descriptions

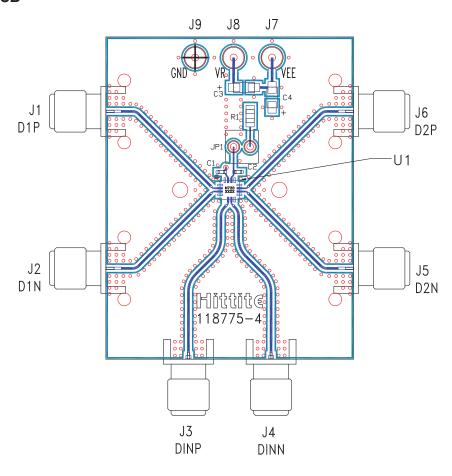
Pin Number	Function	Description	Interface Schematic
1, 4, 5, 8, 9, 12	GND	Signal Grounds	→ GND =
2, 3 10, 11	D1P, D1N D2N, D2P	Differential Clock / Data Outputs: Current Mode Logic (CML) referenced to positive supply.	GND GND O GND DxP O O DxN
6, 7	DINP, DINN	Differential Clock / Data Inputs: Current Mode Logic (CML) referenced to positive supply	GND GND DINPO DINN
13, 16	GND	Supply Ground	○ GND =
14	VR	Output level control. Output level may be adjusted by either applying a voltage to VR per "Output Differential vs. VR" plot.	VR 0
15, Package Base	Vee	Negative Supply	

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Evaluation PCB



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List of Materials for Evaluation PCB 118777 [1]

Item	Description	
J1 - J6	PCB Mount SMA RF Connectors	
J7 - J9	DC Pin	
JP1	0.1" Header with Shorting Jumper	
C1, C2	100 pF, Capacitor, 0402 Pkg	
C3, C4	4.7 μF Capacitor, Tantalum	
R1	10 Ohm Resistor, 0603 Pkg.	
U1	HMC720LP3E High Speed Logic, Fanout Buffer	
PCB [2]	118775 Evaluation Board	

[1] Reference this number when ordering complete evaluation PCB $\,$

[2] Circuit Board Material: Arlon 25FR or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed packaged base should be connected to Vee. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. Install jumper on JP1 to short VR to GND for normal operation.



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Application Circuit

